

INVITATION TO NATIONAL COMPETITIVE BID For the Procurement of Mini Fusion Splicing Machine

Floating Date: As of May 22, 2018

Closing Date: May 22, 2018

RFQ No. 3631277

REQUIREMENTS

1. Ethio telecom intends to sign a Master Frame Agreement (MFA) contract for one (1) year with a possibility of extension up to a maximum of 3 years with the finally awarded bidder(s). Hence, ethio telecom invites all interested and eligible bidders by this **National Competitive Bid (NCB)** for the procurement of **Mini Fusion Splicing Machine with RFQ No. 3631277**. The Tender remains floating from **May 22, 2018 to June 11, 2018**.

No	Description of Items	Unit	Initial forecast order Qty.	RFQ No.
1	Mini Fusion Splicing Machine	pcs	30	3631277

Bid documents can be obtained from ethio telecom's Head Office, Room No. 206 during office hours upon payment of a non-refundable fee of Birr **50.00 (Birr Fifty only)**.

2. Interested bidders are expected to fulfill the requirements stated here below:
 - a. Bid Security;
 - b. Availability of Letter of Authorization to sign the bid offers;
 - c. Anti-bribery pledge form;
 - d. Bidders should have a valid and renewed trade license for the year;
 - e. Bidders should be VAT registered;
 - f. One piece of sample should be provided.
3. All Bids must be accompanied by a bid security in the amount of **Birr 50,000.00 (fifty Thousand only)**
4. The bid bond shall be furnished in one of the following forms: -
 - a) Certified Cheque /CPO issued by a recognized domestic bank or
 - b) Bond issued by and/or confirmed through a recognized/reputable domestic bank.
 - 3.1 The Bank that issues the bond as per 3.1 (b)
 - 3.2 Here above shall **unequivocally guarantee to pay the purchaser immediately upon the first written demand of payment**. The Purchaser's written demand of payment shall not be subject to any condition whatsoever.
 - 3.3 The bond issuing bank shall clearly incorporate the content stated under Clause here above on the issued bond.
 - 3.4 Sealed bids marked as: "Tender for the Supply of **Mini Fusion Splicing Machine with (RFQ NO. 3631277)** and be addressed to:

**Ethio telecom
Churchill Road
Head Quarter
Sourcing and Facilities Division
2nd Floor, Room No. 214
P. O. Box: 1047, Addis Ababa, Ethiopia**

- 4 Bid proposal will be received at the **Churchill Road, Head Quarter 2nd Floor, Room No. 214, before or on Jun 11, 2018 until 5:00 P.M.** Bids presented by any bidder after the closing date shall not be accepted.
- 5 Bids received in time and fulfilling the other formalities shall be opened in the presence of interested bidders or their legal representatives **on Jun 12, 2018 at 10:00 A.M, at Churchill Road, Head Quarter 2nd Floor, Room No. 210.**
- 6 Partial bid is not allowed.
- 7 No one is allowed to duplicate or transfer the bidding document that she/he acquired to participate under this invitation.
- 8 Bidders are seriously advised to read and comply with the instructions provided in this bidding document.
- 9 Ethio telecom reserves the right to reject all or parts of this bid.